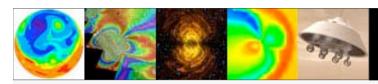




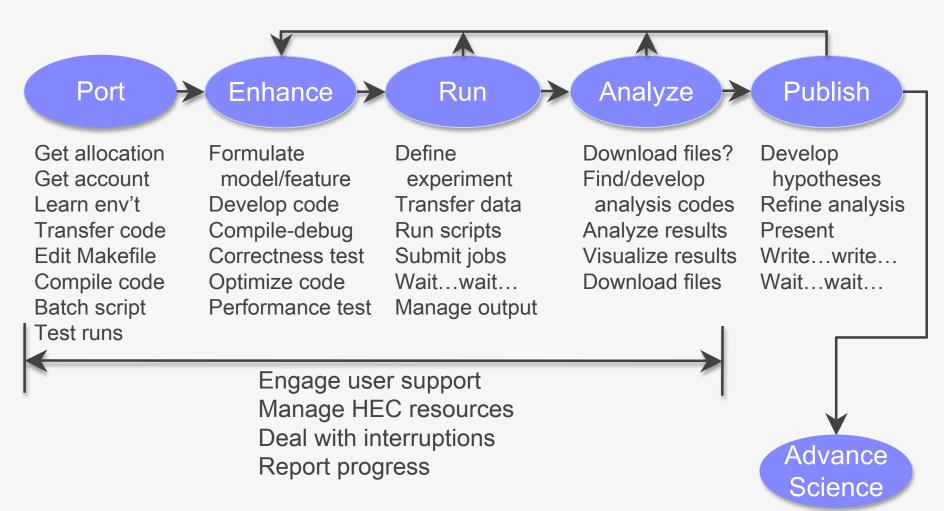
### **Outline**

- SMD's Current Computational Modeling Environment
- Technology Trends
  - Applications
  - Computational Architectures
  - Storage and I/O
  - Software Development Tools
  - User Interface/Environment
  - User Services

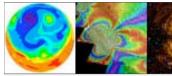




### Typical SMD HEC User Workflow



How could technology advancements accelerate your HEC workflow?





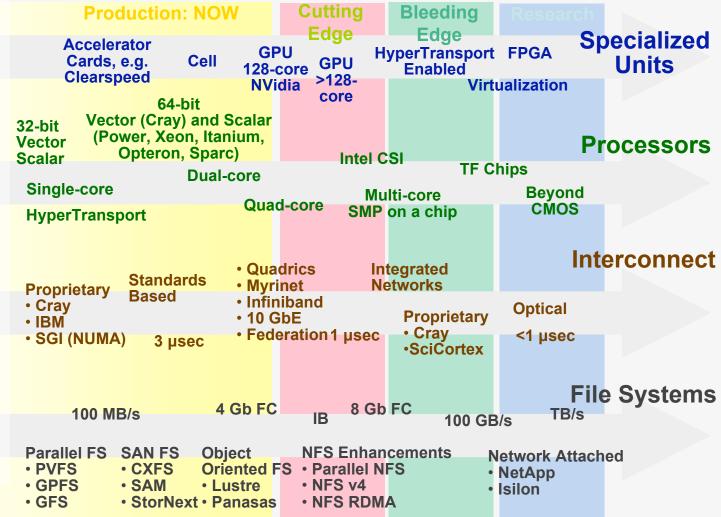




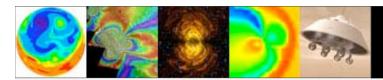
### Trends in Computational Architecture Components

#### **General Trends**

- Multi-core is here to stay
- Very few clock speed bumps for the future
- Multiprocessing element paradigm necessary
- Continued imbalance of processing power and data bandwidth
- Commodity interconnects overtaking proprietary interconnects
- Low power
- Virtualization



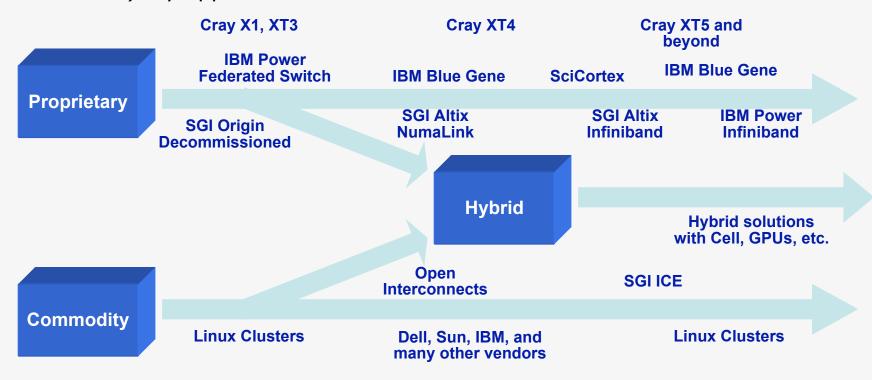
**Increasing IT Capability Over Time** 

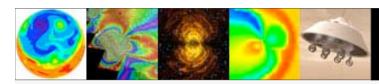




### **Computational Architectures**

- Representative Technologies: cluster, single system image, multi-core, GPU, FPGA, cell, etc.; memory, memory bandwidth; Interconnect bandwidth and latency
  - Adoption of commodity components (processors, interconnect, memory, etc.)
  - Trend toward hybrid computing systems for computational systems
- Leading Question: What computing system characteristics are required by (or best for) my application?

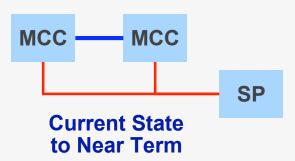




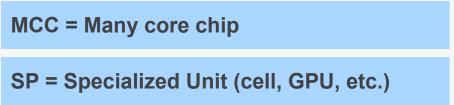


### Chip Architectures

- Multi-core is here to stay; soon to be many-core and many type of cores in a socket
- Push to embed specialized units on the same mother board and eventually the same chip as generalized compute units
- Power envelopes per socket are staying constant; regulation of power at the chip level
- Leading Question: What chip characteristics are required by (or best for) my application?



On board many core chips connected via a high speed interconnect like Hyper-transport. Specialized units are connected through standardized I/O like PCI.

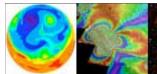




On board many core chips connected via a high speed interconnect like Hyper-transport to not only other many core chips but also specialized units integrated into the board.



Finally, specialized units will be integrated onto the many core chip itself.









### Storage and Archiving Technology Trends

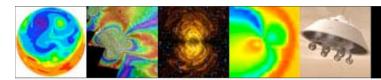
<b>General Trends</b>	Production: NOW Cutting Bleeding Research	
<ul> <li>Disk drive capacities will continue to</li> </ul>	Vendor Specific Direct Attached SAS New Hardware Chicat Oriented	Diek
increase	FC Blade Storage • Metadata Solid State	Disk
<ul> <li>Imbalance between the disk drive capacity and the speed</li> </ul>	Cache Servers  1 GB/s  100 GB Drives  1 TB D	
resulting in slower but	Starblant New Libraries	Archive
bigger drives	DMF HIGH RAS HSM Solid State	HSM Tape
<ul> <li>Larger data sets which take longer to move</li> </ul>	SAM-FS 200 GB 500 GB TB Tapes HPSS Tapes Tapes Unitree TB Tapes  Multiple TB Tapes TB Tapes TB Tapes	
Push for	Integrated Wide	Storage
storing more data on disk	HSM and SAN Area SAN TB/s	Area Networks
Tape remains the cheapest storage environment for the near term (5 years)	SAN File Network Systems Attached CXFS NetApp StorNext Isilon GPFS NFS  100 GB/s  New Standards and Devices iSCSI FCIP iFCP Increasing IT Capability Ov	ver Time





### Data and I/O: Hardware

- Representative Technologies: on-line storage (e.g., spinning disks; volume, stagging, lifetime), archive I/O, archival hardware (e.g., tape silos)
- On-line Storage
  - Disk speeds have not kept up with the throughput requirements for HPC
  - The only way to get the throughput needed is to have lots of disks
  - New disk technologies and capabilities have emerged to provide a much better price performance for near line disk
    - o Beyond RAID: MAID, SAID
    - o Beyond FC: SATA, SAS
  - De-duplication and compression technologies may allow for better disk usage, but may come at a performance cost
- Archive
  - Given the volume of data handled by the HPC centers, archive technologies will remain
    - Tape will remain the most cost effective long term solution
  - Can de-duplication help within an archive system?
- Leading Question: What hardware storage system characteristics are required by (or best for) my application?





### Data and I/O: Software

- Representative Technologies: file systems (e.g., global), system I/O (volume, frequency)
- File Systems
  - Global parallel file systems: IBM GPFS, Sun Lustre, PVFS, and more
  - Perhaps one of the most difficult sub-system to support for an HPC center
    - o File systems tend to cause more problems on an HPC system than any other issue
    - $_{\odot}\text{User}$  applications exercise the file systems in ways that the file system developers did not imagine
  - Interoperability between file systems remains lacking
    - o Users and centers are forced to employ slower technologies, like NFS, scp, bbftp, etc.
    - NFSv4 shows some promise

#### Data Management

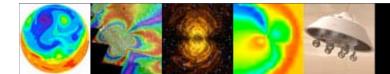
- There is a need to capture metadata to catalogue, search, query, find, and read data sets for long periods of time
- This goes beyond knowing where the data files are stored on disk or tape to supporting the dataflow from job setup through the entire workflow process
- Leading Question: What software storage system characteristics are required by (or best for) my application?





### **Program Development**

- Architectural trends:
  - Many-core chips leading to larger shared memory nodes
  - Deeper memory hierarchies
  - Complex interconnection networks
  - Hyper-threading (fast thread switching) to hide memory latency
  - Accelerators/Coprocessors (GPGPU, Cell, FPGA)
- Challenges for models/languages/tools:
  - A high level of abstraction for the user to express the application (as close to the domain as possible)
  - Enough information for the compiler/runtime system to effectively exploit the target architectures
  - Trade-off between portability/maintainability versus performance
  - Feedback on performance implications of code segments





### Program Development: Models/Languages

#### Current:

- MPI:
  - o standard approach for distributed memory systems;
  - o provides no support for other architectural issues
- OpenMP:
  - o focus on shared memory and loop parallelism; recent support for task parallelism;
  - o does not scale in most cases
- Hybrid (MPI + OpenMP):
  - o works well in some cases
  - o adds complexity to the program
- Higher level approaches Matlab/StarP; optimized libraries MKL, LAPACK
  - o applicable to codes if bulk of computation can utilize optimized third party code;
  - o can provide portability

#### Emerging Technologies:

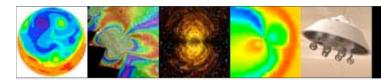
- Partitioned Global Array Space (PGAS) UPC, CAF, Titanium:
  - o for distributed memory system -> explicit data "movement" using a global index space;
  - o solves one issue, no support for other challenges
- Specialized CUDA, Brook, RapidMind ... :
  - o some are non-portable due to focus on specialized hardware,
  - o others are not proven for large applications
- High Productivity Computing Systems (HPCS) X10, Chapel, Fortress:
  - o focus on productivity and programming-in-the-large;
  - o relying on compiler technology to enhance performance





### Program Development: Tools

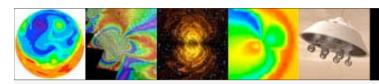
- Computer-aided parallelization:
  - CAPO: OpenMP
  - ParaWise: domain decomposition/MPI
- Debugging Tools:
  - TotalView, DDT: general purpose, MPI, OpenMP, many platforms
  - ThreadChecker: race detection on Intel platforms
  - Valgrind, Electric Fence, Purify: memory debugging
- Performance Tools:
  - Tau, OpenSpeedShop, Vampir, Paraver: general purpose
  - Vtune: Intel platform
  - Perfsuite: from NCSA, Intel only
  - MPInside: SGI only
  - PAPI: library for access to hardware counters





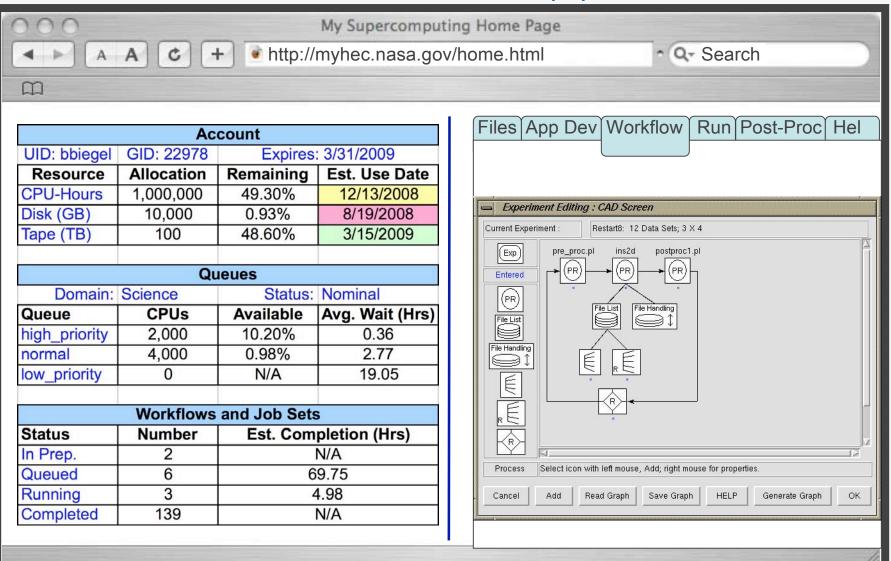
### User Interface/Environment (1)

- Standard user interface to HEC resources: command line
  - account/resource/file management; help requests
  - develop/debug your own codes using C or Fortran
  - run jobs using arcane batch and script files
  - wait for job(s) to complete; if they fail, manually restart
  - manage and post-process output files
  - copy results to local computer to view or print
  - repeat...
- What would be a more productive interface to HEC systems and services than SSH and a command line?
  - web interface to resources, queues, and help system
  - prototype codes in higher level or mathematical language
  - application frameworks (e.g., ESMF) to incorporate algorithms, link models, compare/validate results, etc.
  - Ensemble and workflow management tools; intelligent environment
  - Real-time (every timestep) rendering and streaming of simulations





### User Interface/Environment (2)







### Trends in User Services

- Support Funding reduced by scientists and technologists
  - Increasing rate of consolidation and remote support
  - Increasing Use of unattended support
    - Online documentation: how-to, fag, wiki
    - Good search tools becoming more important
    - User access to Help Desk ticket systems: R/T, Remedy, etc.
  - Specialized, local help by defacto local experts
    - o End users instead of support professionals
- Complexity and interconnection of computing environments increasing demands for sophisticated users
  - Tools, compilers, access models
  - Need for code migration from platform to platform